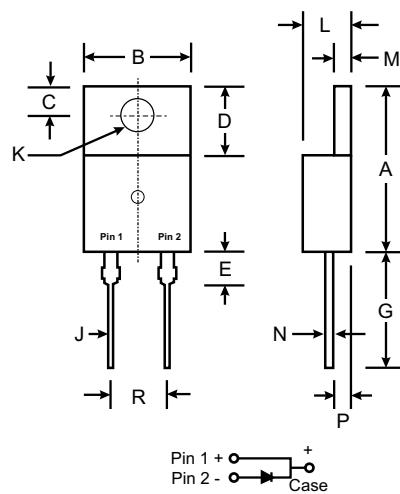


Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Plastic Material: UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 2.24 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



TO-220AC		
Dim	Min	Max
A	14.22	15.88
B	9.65	10.67
C	2.54	3.43
D	5.84	6.86
E	—	6.35
G	12.70	14.73
J	0.51	1.14
K	3.53Ø	4.09Ø
L	3.56	4.83
M	1.14	1.40
N	0.30	0.64
P	2.03	2.92
R	4.83	5.33

All Dimensions in mm

Maximum Ratings and Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	MBR 1030	MBR 1035	MBR 1040	MBR 1045	MBR 1050	MBR 1060	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	35	40	45	50	60	V
RMS Reverse Voltage	$V_R(\text{RMS})$	21	24.5	28	31.5	35	42	V
Average Rectified Output Current (Note 1) @ $T_C = 125^\circ\text{C}$	I_O			10				A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}			150				A
Forward Voltage Drop @ $I_F = 10\text{A}$, $T_C = 25^\circ\text{C}$ @ $I_F = 10\text{A}$, $T_C = 125^\circ\text{C}$	V_{FM}		0.84 0.57		0.95 0.70			V
Peak Reverse Current @ $T_C = 25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_C = 125^\circ\text{C}$	I_{RM}		0.1 15		0.1 25			mA
Typical Junction Capacitance (Note 2)	C_J		400					pF
Typical Thermal Resistance Junction to Case (Note 1)	$R_{\theta JC}$		2.5					°C/W
Voltage Rate of Change (Rated V_R)	dV/dt		1000					V/ μs
Operating and Storage Temperature Range	T_J , T_{STG}			-65 to +150				°C

Notes: 1. Thermal resistance junction to case mounted on heatsink.
2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

